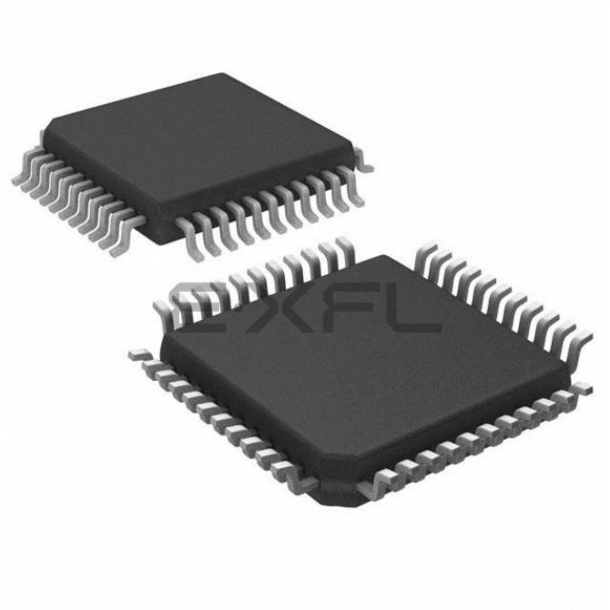

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What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "Embedded - Microcontrollers"

Details	
Product Status	Obsolete
Core Processor	PIC
Core Size	8-Bit
Speed	8MHz
Connectivity	UART/USART
Peripherals	POR, PWM, WDT
Number of I/O	33
Program Memory Size	4KB (2K x 16)
Program Memory Type	OTP
EEPROM Size	-
RAM Size	232 x 8
Voltage - Supply (Vcc/Vdd)	2.5V ~ 6V
Data Converters	-
Oscillator Type	External
Operating Temperature	0°C ~ 70°C (TA)
Mounting Type	Surface Mount
Package / Case	44-QFP
Supplier Device Package	44-MQFP (10x10)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic17lc42a-08-pq

3.0 ARCHITECTURAL OVERVIEW

The high performance of the PIC17C4X can be attributed to a number of architectural features commonly found in RISC microprocessors. To begin with, the PIC17C4X uses a modified Harvard architecture. This architecture has the program and data accessed from separate memories. So the device has a program memory bus and a data memory bus. This improves bandwidth over traditional von Neumann architecture, where program and data are fetched from the same memory (accesses over the same bus). Separating program and data memory further allows instructions to be sized differently than the 8-bit wide data word. PIC17C4X opcodes are 16-bits wide, enabling single word instructions. The full 16-bit wide program memory bus fetches a 16-bit instruction in a single cycle. A two-stage pipeline overlaps fetch and execution of instructions. Consequently, all instructions execute in a single cycle (121 ns @ 33 MHz), except for program branches and two special instructions that transfer data between program and data memory.

The PIC17C4X can address up to 64K x 16 of program memory space.

The **PIC17C42** and **PIC17C42A** integrate 2K x 16 of EPROM program memory on-chip, while the **PIC17CR42** has 2K x 16 of ROM program memory on-chip.

The **PIC17C43** integrates 4K x 16 of EPROM program memory, while the **PIC17CR43** has 4K x 16 of ROM program memory.

The **PIC17C44** integrates 8K x 16 EPROM program memory.

Program execution can be internal only (microcontroller or protected microcontroller mode), external only (microprocessor mode) or both (extended microcontroller mode). Extended microcontroller mode does not allow code protection.

The PIC17CXX can directly or indirectly address its register files or data memory. All special function registers, including the Program Counter (PC) and Working Register (WREG), are mapped in the data memory. The PIC17CXX has an orthogonal (symmetrical) instruction set that makes it possible to carry out any operation on any register using any addressing mode. This symmetrical nature and lack of 'special optimal situations' make programming with the PIC17CXX simple yet efficient. In addition, the learning curve is reduced significantly.

One of the PIC17CXX family architectural enhancements from the PIC16CXX family allows two file registers to be used in some two operand instructions. This allows data to be moved directly between two registers without going through the WREG register. This increases performance and decreases program memory usage.

The PIC17CXX devices contain an 8-bit ALU and working register. The ALU is a general purpose arithmetic unit. It performs arithmetic and Boolean functions between data in the working register and any register file.

The ALU is 8-bits wide and capable of addition, subtraction, shift, and logical operations. Unless otherwise mentioned, arithmetic operations are two's complement in nature.

The WREG register is an 8-bit working register used for ALU operations.

All PIC17C4X devices (except the PIC17C42) have an 8 x 8 hardware multiplier. This multiplier generates a 16-bit result in a single cycle.

Depending on the instruction executed, the ALU may affect the values of the Carry (C), Digit Carry (DC), and Zero (Z) bits in the STATUS register. The C and DC bits operate as a borrow and digit borrow out bit, respectively, in subtraction. See the `SUBLW` and `SUBWF` instructions for examples.

Although the ALU does not perform signed arithmetic, the Overflow bit (OV) can be used to implement signed math. Signed arithmetic is comprised of a magnitude and a sign bit. The overflow bit indicates if the magnitude overflows and causes the sign bit to change state. Signed math can have greater than 7-bit values (magnitude), if more than one byte is used. The use of the overflow bit only operates on bit6 (MSb of magnitude) and bit7 (sign bit) of the value in the ALU. That is, the overflow bit is not useful if trying to implement signed math where the magnitude, for example, is 11-bits. If the signed math values are greater than 7-bits (15-, 24- or 31-bit), the algorithm must ensure that the low order bytes ignore the overflow status bit.

Care should be taken when adding and subtracting signed numbers to ensure that the correct operation is executed. Example 3-1 shows an item that must be taken into account when doing signed arithmetic on an ALU which operates as an unsigned machine.

EXAMPLE 3-1: SIGNED MATH

```
Hex Value      Signed Value     Unsigned Value
               Math             Math

  FFh            -127             255
+ 01h          +    1           +   1
=  ?           = -126 (FEh)     =   0 (00h);
                                Carry bit = 1
```

```
Signed math requires the result in REG to
be FEh (-126). This would be accomplished
by subtracting one as opposed to adding
one.
```

Simplified block diagrams are shown in Figure 3-1 and Figure 3-2. The descriptions of the device pins are listed in Table 3-1.

5.4 Interrupt Operation

Global Interrupt Disable bit, GLINTD (CPUSTA<4>), enables all unmasked interrupts (if clear) or disables all interrupts (if set). Individual interrupts can be disabled through their corresponding enable bits in the INTSTA register. Peripheral interrupts need either the global peripheral enable PEIE bit disabled, or the specific peripheral enable bit disabled. Disabling the peripherals via the global peripheral enable bit, disables all peripheral interrupts. GLINTD is set on reset (interrupts disabled).

The `RETFIE` instruction allows returning from interrupt and re-enable interrupts at the same time.

When an interrupt is responded to, the GLINTD bit is automatically set to disable any further interrupt, the return address is pushed onto the stack and the PC is loaded with interrupt vector. There are four interrupt vectors to reduce interrupt latency.

The peripheral interrupt vector has multiple interrupt sources. Once in the peripheral interrupt service routine, the source(s) of the interrupt can be determined by polling the interrupt flag bits. The peripheral interrupt flag bit(s) must be cleared in software before re-enabling interrupts to avoid continuous interrupts.

The PIC17C4X devices have four interrupt vectors. These vectors and their hardware priority are shown in Table 5-1. If two enabled interrupts occur “at the same time”, the interrupt of the highest priority will be serviced first. This means that the vector address of that interrupt will be loaded into the program counter (PC).

TABLE 5-1: INTERRUPT VECTORS/ PRIORITIES

Address	Vector	Priority
0008h	External Interrupt on RA0/ INT pin (INTF)	1 (Highest)
0010h	TMR0 overflow interrupt (T0IF)	2
0018h	External Interrupt on T0CKI (T0CKIF)	3
0020h	Peripherals (PEIF)	4 (Lowest)

Note 1: Individual interrupt flag bits are set regardless of the status of their corresponding mask bit or the GLINTD bit.

Note 2: When disabling any of the INTSTA enable bits, the GLINTD bit should be set (disabled).

Note 3: For the PIC17C42 only:
If an interrupt occurs while the Global Interrupt Disable (GLINTD) bit is being set, the GLINTD bit may unintentionally be re-enabled by the user’s Interrupt Service Routine (the `RETFIE` instruction). The events that would cause this to occur are:

1. An interrupt occurs simultaneously with an instruction that sets the GLINTD bit.
2. The program branches to the Interrupt vector and executes the Interrupt Service Routine.
3. The Interrupt Service Routine completes with the execution of the `RETFIE` instruction. This causes the GLINTD bit to be cleared (enables interrupts), and the program returns to the instruction after the one which was meant to disable interrupts.

The method to ensure that interrupts are globally disabled is:

1. Ensure that the GLINTD bit was set by the instruction, as shown in the following code:

```
LOOP   BSF    CPUSTA, GLINTD ; Disable Global
                             ; Interrupt
       BTFSS  CPUSTA, GLINTD ; Global Interrupt
                             ; Disabled?
       GOTO   LOOP           ; NO, try again
                             ; YES, continue
                             ; with program
                             ; low
```

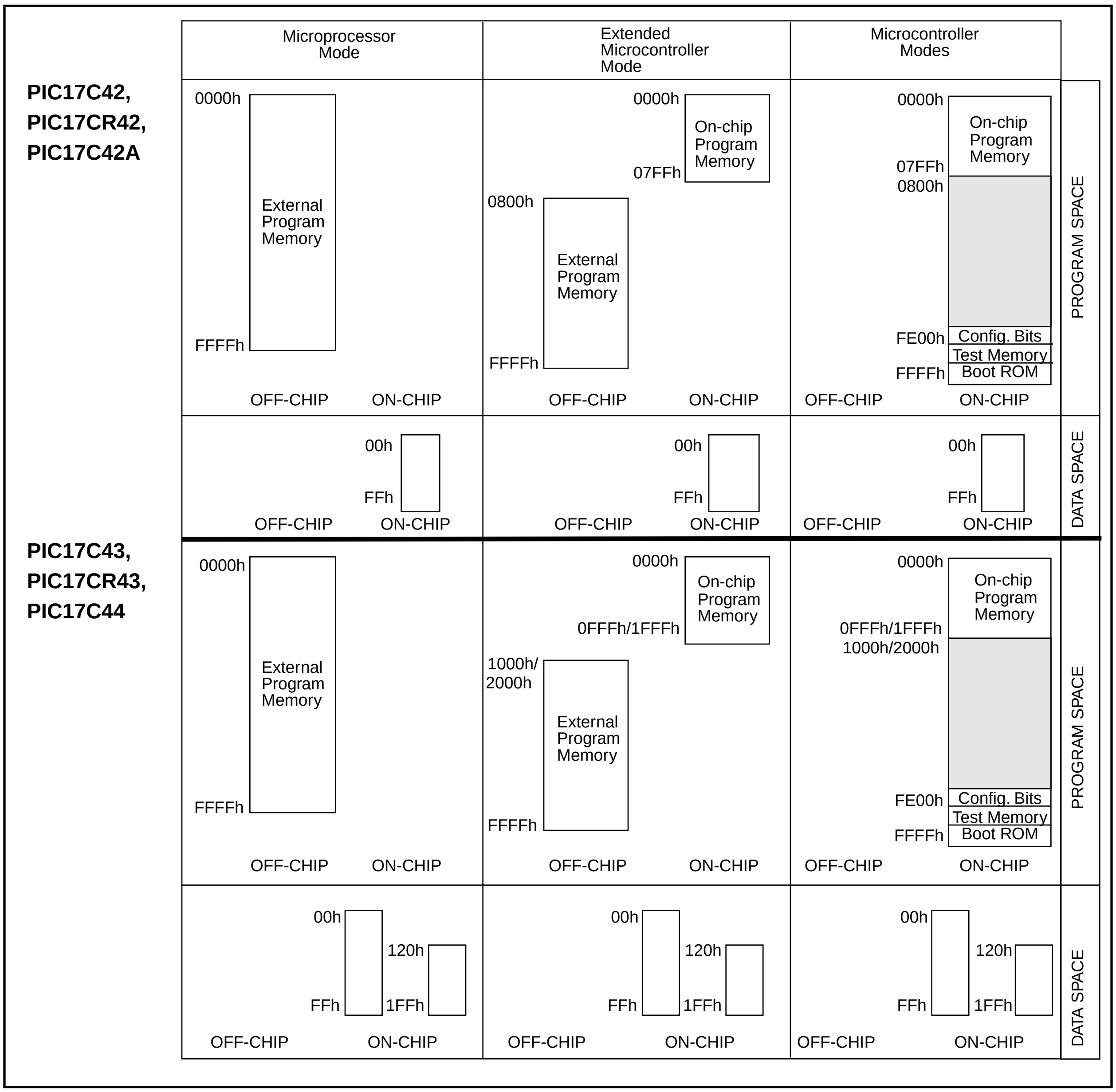
TABLE 6-1: MODE MEMORY ACCESS

Operating Mode	Internal Program Memory	Configuration Bits, Test Memory, Boot ROM
Microprocessor	No Access	No Access
Microcontroller	Access	Access
Extended Microcontroller	Access	No Access
Protected Microcontroller	Access	Access

The PIC17C4X can operate in modes where the program memory is off-chip. They are the microprocessor and extended microcontroller modes. The microprocessor mode is the default for an unprogrammed device.

Regardless of the processor mode, data memory is always on-chip.

FIGURE 6-2: MEMORY MAP IN DIFFERENT MODES



7.3 Table Reads

The table read allows the program memory to be read. This allows constant data to be stored in the program memory space, and retrieved into data memory when needed. Example 7-2 reads the 16-bit value at program memory address TBLPTR. After the dummy byte has been read from the TABLATH, the TABLATH is loaded with the 16-bit data from program memory address TBLPTR + 1. The first read loads the data into the latch, and can be considered a dummy read (unknown data loaded into 'f'). INDF0 should be configured for either auto-increment or auto-decrement.

EXAMPLE 7-2: TABLE READ

```
MOVLW   HIGH (TBL_ADDR) ; Load the Table
MOVWF   TBLPTRH         ;   address
MOVLW   LOW (TBL_ADDR)  ;
MOVWF   TBLPTRL         ;
TABLRD  0,0,DUMMY       ; Dummy read,
                        ;  Updates TABLATCH
TLRD    1, INDF0        ; Read HI byte
                        ;   of TABLATCH
TABLRD  0,1,INDF0       ; Read LO byte
                        ;   of TABLATCH and
                        ;   Update TABLATCH
```

FIGURE 7-7: TABLRD TIMING

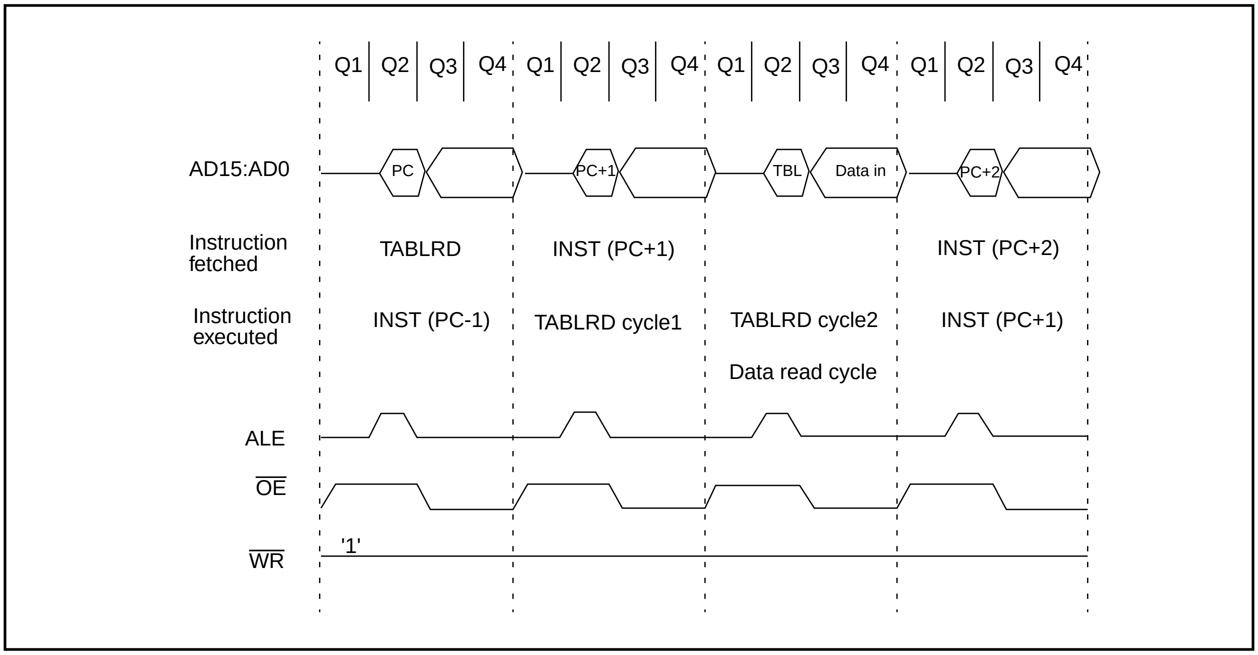
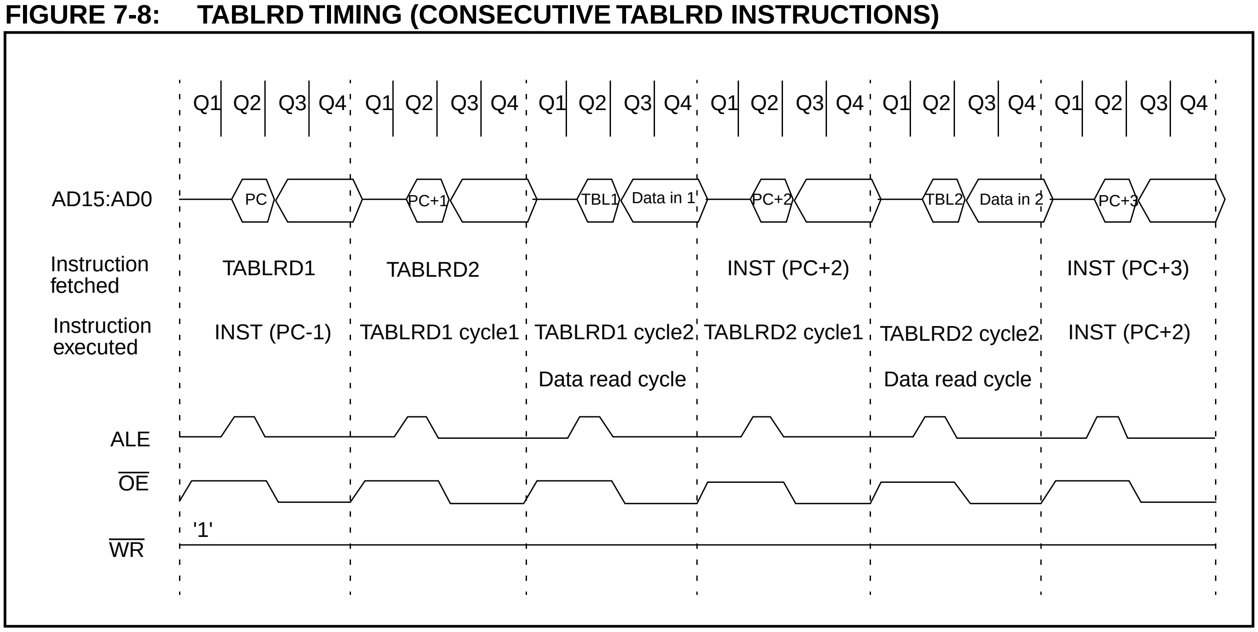


FIGURE 7-8: TABLRD TIMING (CONSECUTIVE TABLRD INSTRUCTIONS)



11.0 TIMER0

The Timer0 module consists of a 16-bit timer/counter, TMR0. The high byte is TMR0H and the low byte is TMR0L. A software programmable 8-bit prescaler makes an effective 24-bit overflow timer. The clock source is also software programmable as either the internal instruction clock or the RA1/T0CKI pin. The control bits for this module are in register T0STA (Figure 11-1).

FIGURE 11-1: T0STA REGISTER (ADDRESS: 05h, UNBANKED)

R/W - 0	R/W - 0	R/W - 0	R/W - 0	R/W - 0	R/W - 0	R/W - 0	U - 0
INTEDG	T0SE	T0CS	PS3	PS2	PS1	PS0	—
bit7							bit0

R = Readable bit
W = Writable bit
U = Unimplemented, Read as '0'
-n = Value at POR reset

bit 7: **INTEDG**: RA0/INT Pin Interrupt Edge Select bit
This bit selects the edge upon which the interrupt is detected
1 = Rising edge of RA0/INT pin generates interrupt
0 = Falling edge of RA0/INT pin generates interrupt

bit 6: **T0SE**: Timer0 Clock Input Edge Select bit
This bit selects the edge upon which TMR0 will increment
<u>When T0CS = 0</u>
1 = Rising edge of RA1/T0CKI pin increments TMR0 and/or generates a T0CKIF interrupt
0 = Falling edge of RA1/T0CKI pin increments TMR0 and/or generates a T0CKIF interrupt
<u>When T0CS = 1</u>
Don't care

bit 5: **T0CS**: Timer0 Clock Source Select bit
This bit selects the clock source for TMR0.
1 = Internal instruction clock cycle (T_{CY})
0 = T0CKI pin

bit 4-1: **PS3:PS0**: Timer0 Prescale Selection bits
These bits select the prescale value for TMR0.

PS3:PS0	Prescale Value
0000	1:1
0001	1:2
0010	1:4
0011	1:8
0100	1:16
0101	1:32
0110	1:64
0111	1:128
1xxx	1:256

bit 0: **Unimplemented**: Read as '0'

12.1.3 USING PULSE WIDTH MODULATION (PWM) OUTPUTS WITH TMR1 AND TMR2

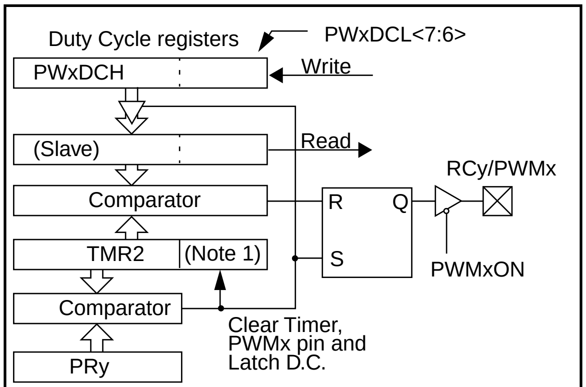
Two high speed pulse width modulation (PWM) outputs are provided. The PWM1 output uses Timer1 as its time-base, while PWM2 may be software configured to use either Timer1 or Timer2 as the time-base. The PWM outputs are on the RB2/PWM1 and RB3/PWM2 pins.

Each PWM output has a maximum resolution of 10-bits. At 10-bit resolution, the PWM output frequency is 24.4 kHz (@ 25 MHz clock) and at 8-bit resolution the PWM output frequency is 97.7 kHz. The duty cycle of the output can vary from 0% to 100%.

Figure 12-5 shows a simplified block diagram of the PWM module. The duty cycle register is double buffered for glitch free operation. Figure 12-6 shows how a glitch could occur if the duty cycle registers were not double buffered.

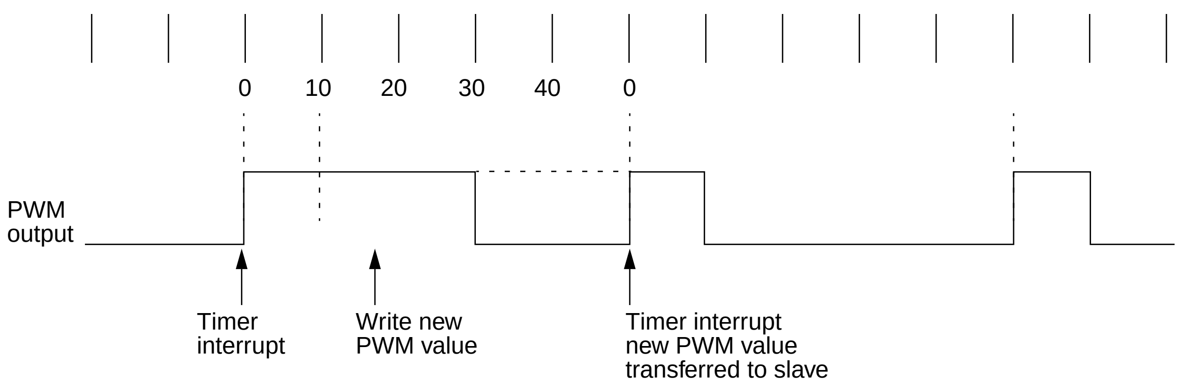
The user needs to set the PWM1ON bit (TCON2<4>) to enable the PWM1 output. When the PWM1ON bit is set, the RB2/PWM1 pin is configured as PWM1 output and forced as an output irrespective of the data direction bit (DDRB<2>). When the PWM1ON bit is clear, the pin behaves as a port pin and its direction is controlled by its data direction bit (DDRB<2>). Similarly, the PWM2ON (TCON2<5>) bit controls the configuration of the RB3/PWM2 pin.

FIGURE 12-5: SIMPLIFIED PWM BLOCK DIAGRAM



Note 1: 8-bit timer is concatenated with 2-bit internal Q clock or 2 bits of the prescaler to create 10-bit time-base.

FIGURE 12-6: PWM OUTPUT



Note The dotted line shows PWM output if duty cycle registers were not double buffered. If the new duty cycle is written after the timer has passed that value, then the PWM does not reset at all during the current cycle causing a “glitch”.

In this example, PWM period = 50. Old duty cycle is 30. New duty cycle value is 10.

FIGURE 13-3: USART TRANSMIT

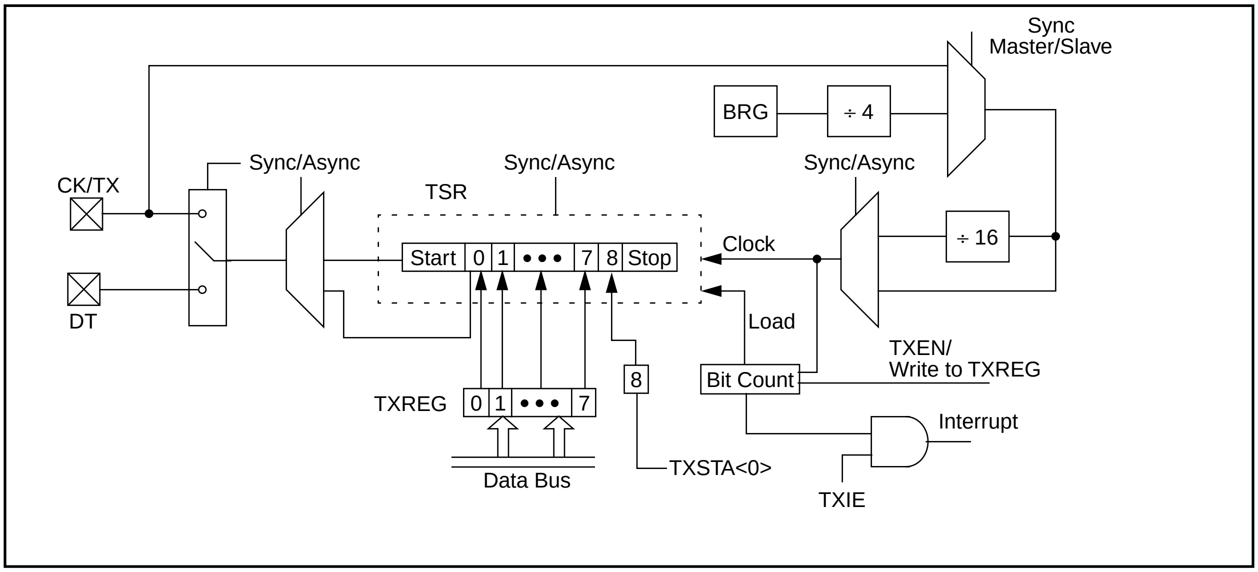
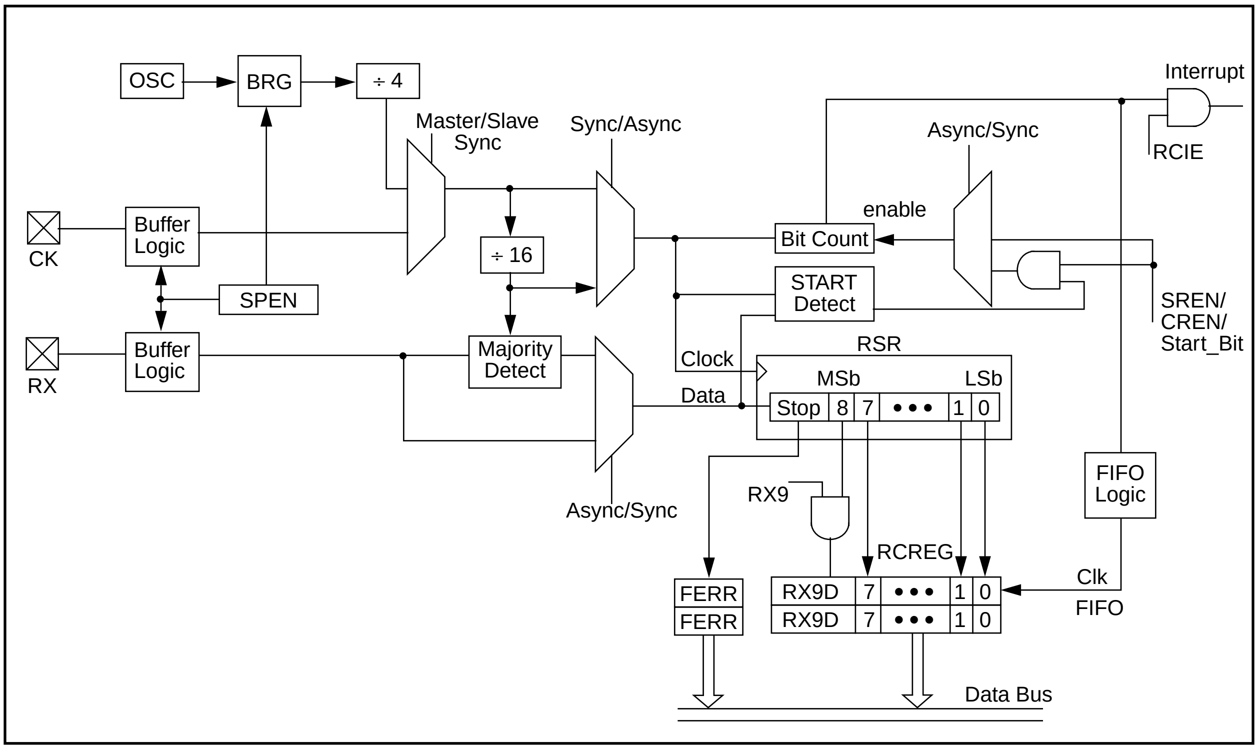


FIGURE 13-4: USART RECEIVE



CLRWDT **Clear Watchdog Timer**

Syntax: [*label*] CLRWDT

Operands: None

Operation:
00h → WDT
0 → WDT postscaler,
1 → $\overline{TO}$
1 → $\overline{PD}$

Status Affected: $\overline{TO}$, $\overline{PD}$

Encoding:

0000	0000	0000	0100

Description: `CLRWDT` instruction resets the watchdog timer. It also resets the prescaler of the WDT. Status bits $\overline{TO}$ and $\overline{PD}$ are set.

Words: 1

Cycles: 1

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read register ALUSTA	Execute	NOP

Example: `CLRWDT`

Before Instruction
WDT counter = ?

After Instruction
WDT counter = 0x00
WDT Postscaler = 0
$\overline{TO}$ = 1
$\overline{PD}$ = 1

COMF **Complement f**

Syntax: [*label*] COMF f,d

Operands: $0 \le f \le 255$
$d \in [0,1]$

Operation: $(\overline{f}) \rightarrow$ (dest)

Status Affected: Z

Encoding:

0001	001d	ffff	ffff

Description: The contents of register 'f' are complemented. If 'd' is 0 the result is stored in WREG. If 'd' is 1 the result is stored back in register 'f'.

Words: 1

Cycles: 1

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read register 'f'	Execute	Write register 'f'

Example: `COMF REG1,0`

Before Instruction
REG1 = 0x13

After Instruction
REG1 = 0x13
WREG = 0xEC

IORWF — Inclusive OR WREG with f

Syntax: [*label*] IORWF f,d

Operands: $0 \le f \le 255$
$d \in [0,1]$

Operation: (WREG) .OR. (f) $\rightarrow$ (dest)

Status Affected: Z

Encoding:

0000	100d	ffff	ffff

Description: Inclusive OR WREG with register 'f'. If 'd' is 0 the result is placed in WREG. If 'd' is 1 the result is placed back in register 'f'.

Words: 1

Cycles: 1

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read register 'f'	Execute	Write to destination

Example: `IORWF RESULT, 0`

Before Instruction
RESULT = 0x13
WREG = 0x91

After Instruction
RESULT = 0x13
WREG = 0x93

LCALL — Long Call

Syntax: [*label*] LCALL k

Operands: $0 \le k \le 255$

Operation: PC + 1 $\rightarrow$ TOS;
k $\rightarrow$ PCL, (PCLATH) $\rightarrow$ PCH

Status Affected: None

Encoding:

1011	0111	kkkk	kkkk

Description: LCALL allows an unconditional subroutine call to anywhere within the 64k program memory space.

First, the return address (PC + 1) is pushed onto the stack. A 16-bit destination address is then loaded into the program counter. The lower 8-bits of the destination address is embedded in the instruction. The upper 8-bits of PC is loaded from PC high holding latch, PCLATH.

Words: 1

Cycles: 2

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read literal 'k'	Execute	Write register PCL
Forced NOP	NOP	Execute	NOP

Example:

```
MOVLW  HIGH(SUBROUTINE)
MOVPF  WREG, PCLATH
LCALL  LOW(SUBROUTINE)
```

Before Instruction
SUBROUTINE = 16-bit Address
PC = ?

After Instruction
PC = Address (SUBROUTINE)

Applicable Devices	42	R42	42A	43	R43	44

FIGURE 17-7: CAPTURE TIMINGS

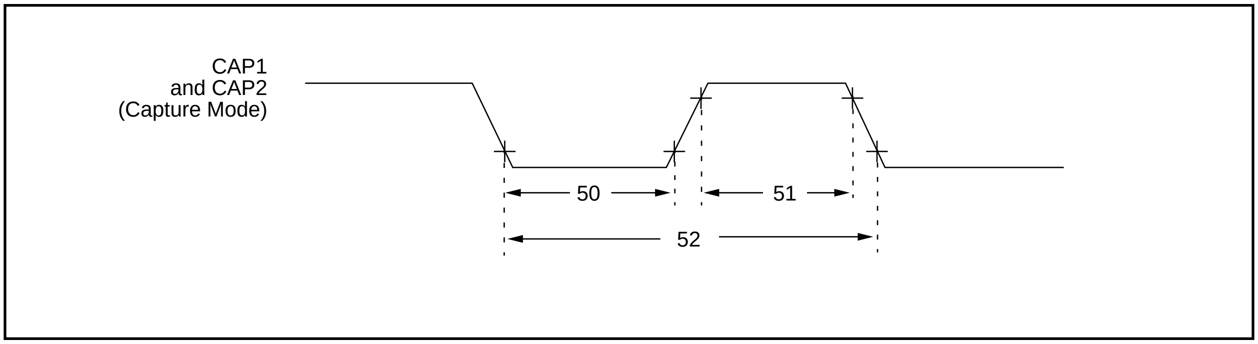


TABLE 17-7: CAPTURE REQUIREMENTS

Parameter No.	Sym	Characteristic	Min	Typ†	Max	Units	Conditions
50	TccL	Capture1 and Capture2 input low time	10 *	—	—	ns	
51	TccH	Capture1 and Capture2 input high time	10 *	—	—	ns	
52	TccP	Capture1 and Capture2 input period	$\frac{2\,T_{CY}}{N}$ §	—	—	ns	N = prescale value (4 or 16)

* These parameters are characterized but not tested.

† Data in “Typ” column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

§ This specification ensured by design.

FIGURE 17-8: PWM TIMINGS

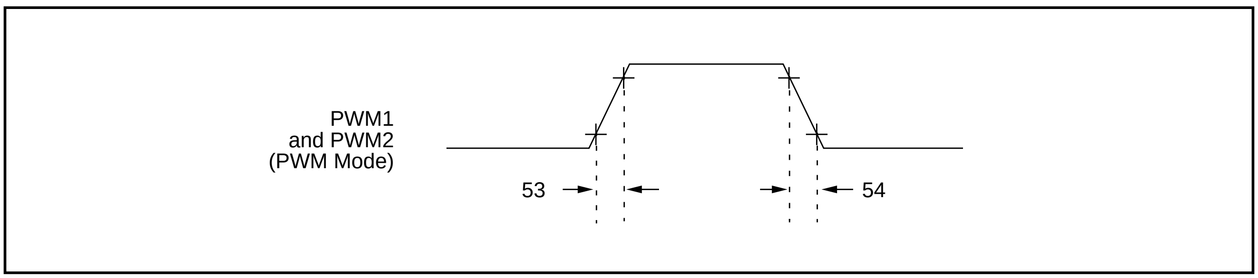


TABLE 17-8: PWM REQUIREMENTS

Parameter No.	Sym	Characteristic	Min	Typ†	Max	Units	Conditions
53	TccR	PWM1 and PWM2 output rise time	—	10 *	35 *§	ns	
54	TccF	PWM1 and PWM2 output fall time	—	10 *	35 *§	ns	

* These parameters are characterized but not tested.

† Data in “Typ” column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

§ This specification ensured by design.

Applicable Devices	42	R42	42A	43	R43	44

FIGURE 19-4: RESET, WATCHDOG TIMER, OSCILLATOR START-UP TIMER, AND POWER-UP TIMER TIMING

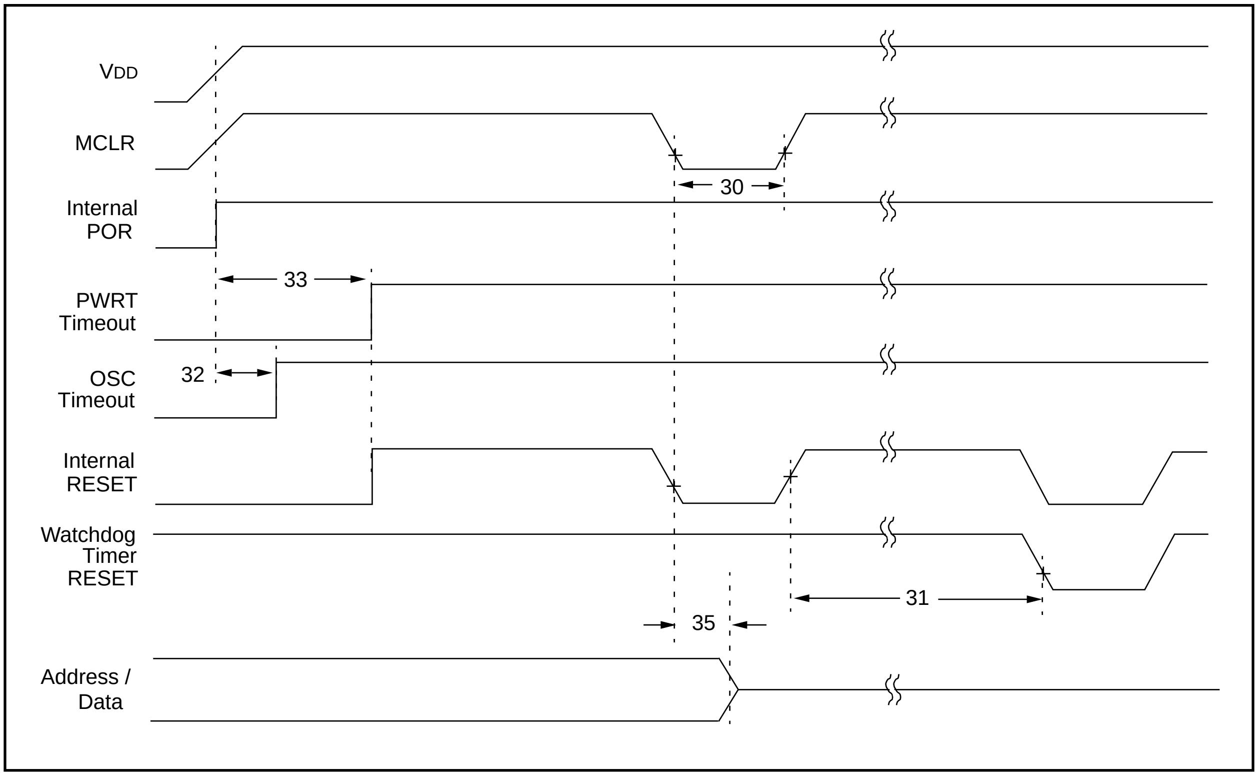


TABLE 19-4: RESET, WATCHDOG TIMER, OSCILLATOR START-UP TIMER AND POWER-UP TIMER REQUIREMENTS

Parameter No.	Sym	Characteristic		Min	Typ†	Max	Units	Conditions
30	TmcL	$\overline{MCLR}$ Pulse Width (low)		100 *	—	—	ns	VDD = 5V
31	Twdt	Watchdog Timer Time-out Period (Prescale = 1)		5 *	12	25 *	ms	VDD = 5V
32	Tost	Oscillation Start-up Timer Period		—	1024TOSC§	—	ms	TOSC = OSC1 period
33	Tpwrt	Power-up Timer Period		40 *	96	200 *	ms	VDD = 5V
35	TmcL2adI	$\overline{MCLR}$ to System Interface bus (AD15:AD0>) invalid	PIC17CR42/42A/43/R43/44	—	—	100 *	ns	
			PIC17LCR42/42A/43/R43/44	—	—	120 *	ns	

* These parameters are characterized but not tested.

† Data in “Typ” column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

‡ These parameters are for design guidance only and are not tested, nor characterized.

§ This specification ensured by design.

Applicable Devices	42	R42	42A	43	R43	44

FIGURE 19-7: CAPTURE TIMINGS

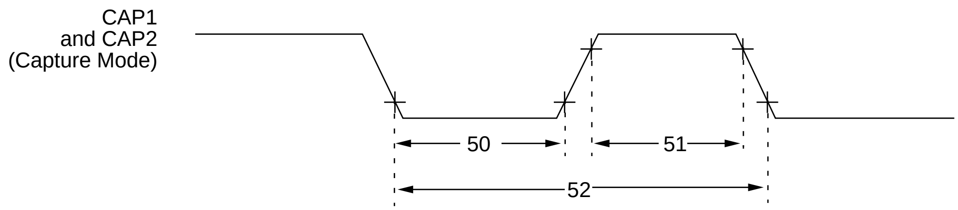


TABLE 19-7: CAPTURE REQUIREMENTS

Parameter No.	Sym	Characteristic	Min	Typ†	Max	Units	Conditions
50	TccL	Capture1 and Capture2 input low time	10 *	—	—	ns	
51	TccH	Capture1 and Capture2 input high time	10 *	—	—	ns	
52	TccP	Capture1 and Capture2 input period	$\frac{2T_{CY}}{N}$ §	—	—	ns	N = prescale value (4 or 16)

* These parameters are characterized but not tested.
† Data in “Typ” column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.
§ This specification ensured by design.

FIGURE 19-8: PWM TIMINGS

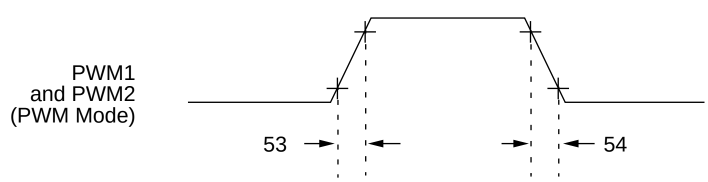


TABLE 19-8: PWM REQUIREMENTS

Parameter No.	Sym	Characteristic	Min	Typ†	Max	Units	Conditions
53	TccR	PWM1 and PWM2 output rise time	—	10 *	35 *§	ns	
54	TccF	PWM1 and PWM2 output fall time	—	10 *	35 *§	ns	

* These parameters are characterized but not tested.
† Data in “Typ” column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.
§ This specification ensured by design.

NOTES:

Applicable Devices	42	R42	42A	43	R43	44

20.0 PIC17CR42/42A/43/R43/44 DC AND AC CHARACTERISTICS

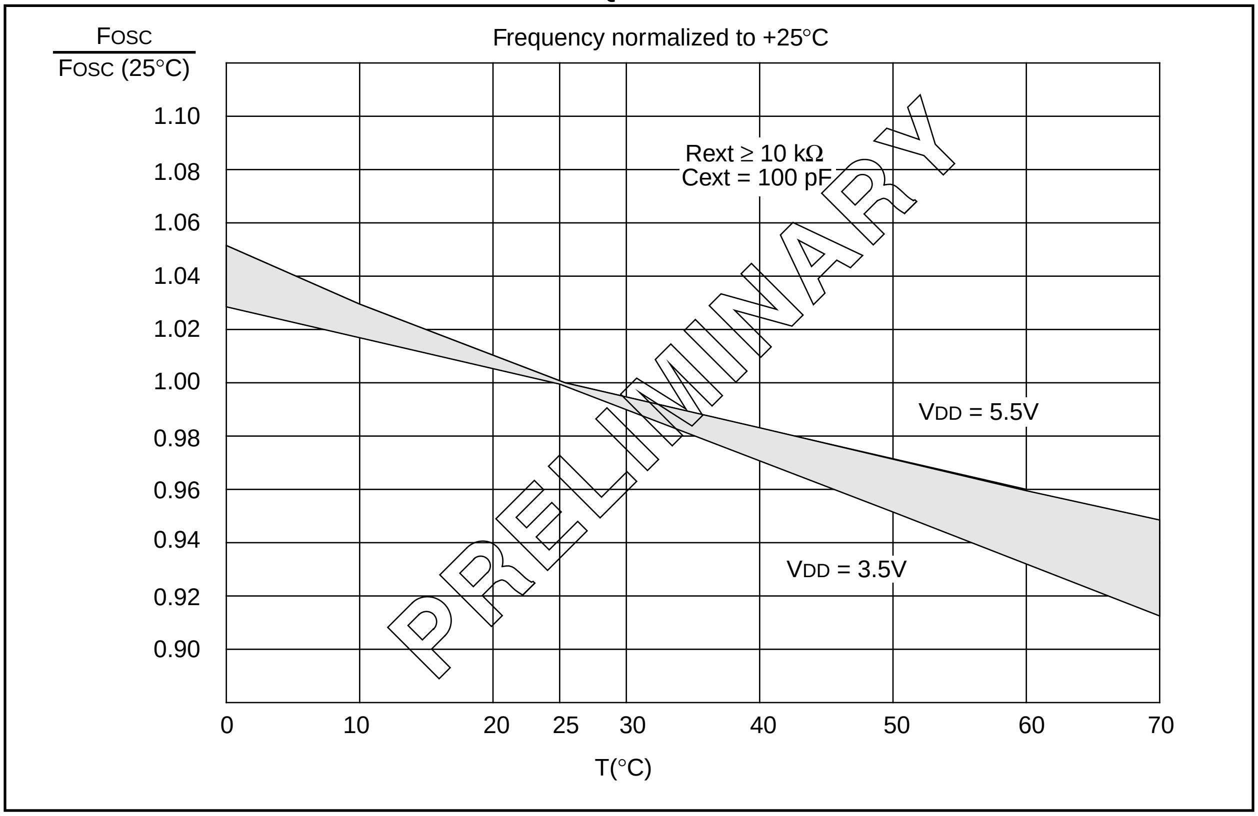
The graphs and tables provided in this section are for design guidance and are not tested nor guaranteed. In some graphs or tables the data presented is outside specified operating range (e.g. outside specified VDD range). This is for information only and devices are ensured to operate properly only within the specified range.

The data presented in this section is a statistical summary of data collected on units from different lots over a period of time. "Typical" represents the mean of the distribution while "max" or "min" represents (mean + 3σ) and (mean - 3σ) respectively where σ is standard deviation.

TABLE 20-1: PIN CAPACITANCE PER PACKAGE TYPE

Pin Name	Typical Capacitance (pF)			
	40-pin DIP	44-pin PLCC	44-pin MQFP	44-pin TQFP
All pins, except $\overline{MCLR}$, VDD, and VSS	10	10	10	10
$\overline{MCLR}$ pin	20	20	20	20

FIGURE 20-1: TYPICAL RC OSCILLATOR FREQUENCY vs. TEMPERATURE



Applicable Devices	42	R42	42A	43	R43	44

FIGURE 20-5: TRANSCONDUCTANCE (gm) OF LF OSCILLATOR vs. VDD

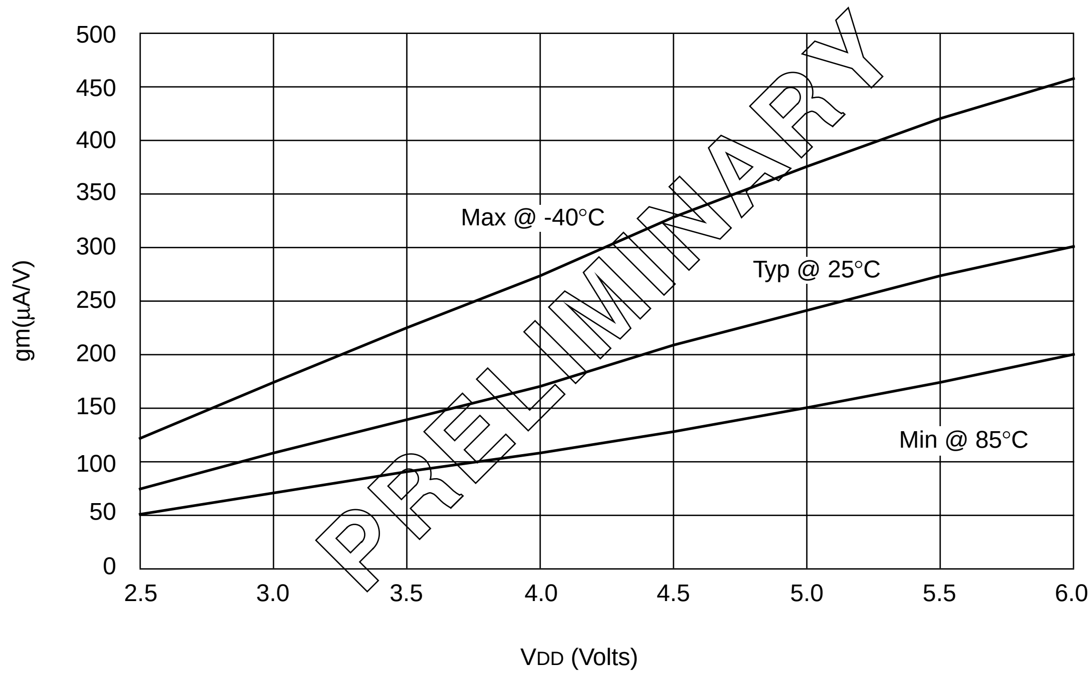
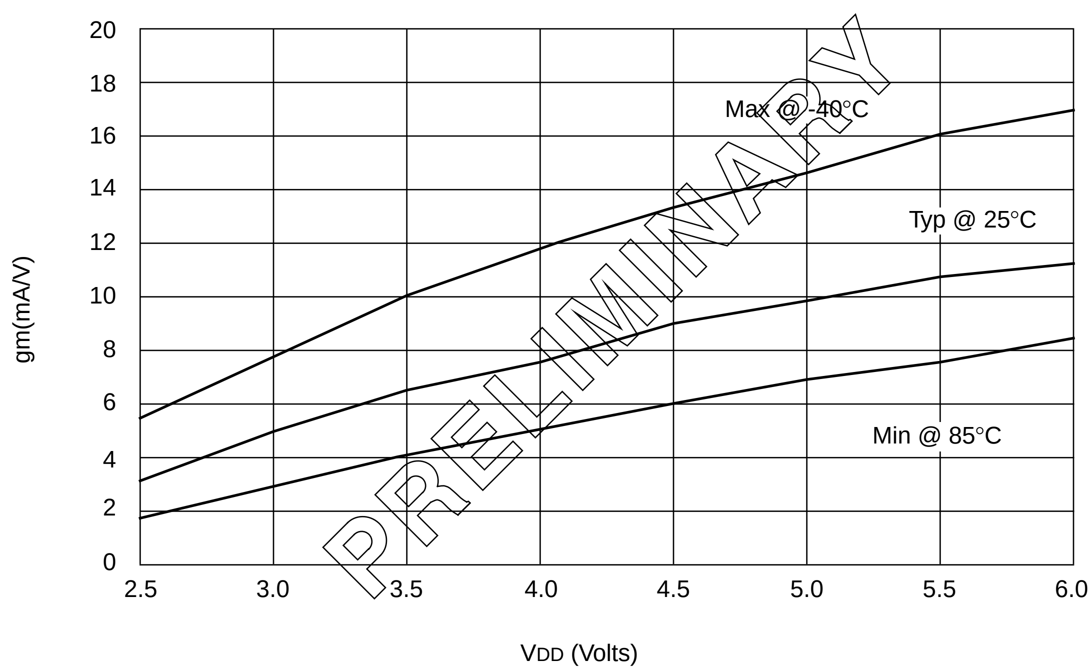
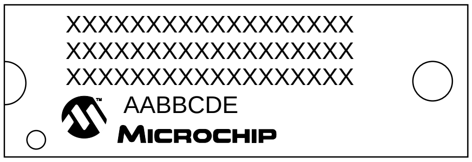


FIGURE 20-6: TRANSCONDUCTANCE (gm) OF XT OSCILLATOR vs. VDD

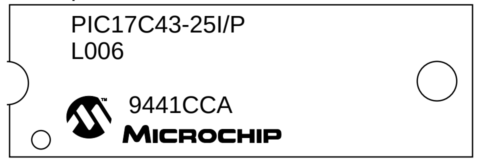


21.6 Package Marking Information

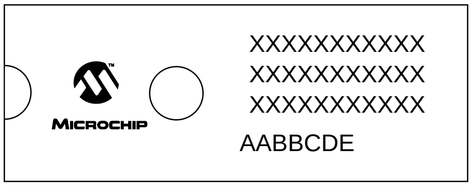
40-Lead PDIP/CERDIP



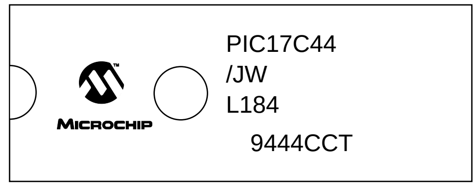
Example



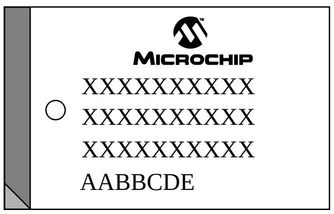
40 Lead CERDIP Windowed



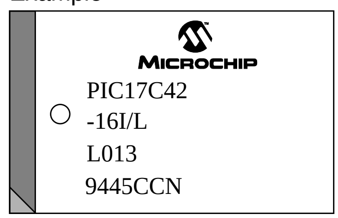
Example



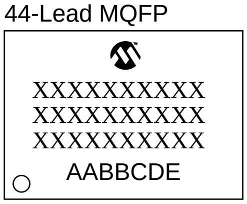
44-Lead PLCC



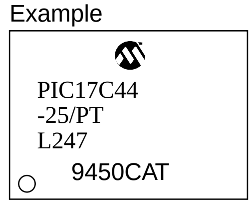
Example



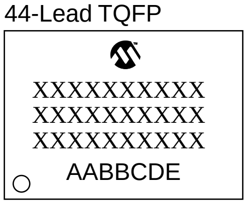
44-Lead MQFP



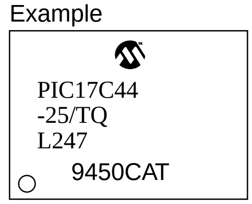
Example



44-Lead TQFP



Example



Legend:	MM...M	Microchip part number information
	XX...X	Customer specific information*
	AA	Year code (last 2 digits of calendar year)
	BB	Week code (week of January 1 is week '01')
	C	Facility code of the plant at which wafer is manufactured C = Chandler, Arizona, U.S.A., S = Tempe, Arizona, U.S.A.
	D	Mask revision number
	E	Assembly code of the plant or country of origin in which part was assembled

Note: In the event the full Microchip part number cannot be marked on one line, it will be carried over to the next line thus limiting the number of available characters for customer specific information.

* Standard OTP marking consists of Microchip part number, year code, week code, facility code, mask rev#, and assembly code. For OTP marking beyond this, certain price adders apply. Please check with your Microchip Sales Office. For QTP devices, any special marking adders are included in QTP price.

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LIST OF EQUATIONS

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01/18/02